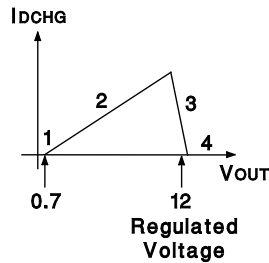


OPERATION (cont.)

At the end of the on time, Q1 is turned off and the R_{ON} current into T_{ON} is again diverted to V_{CC} . Thus the current through R_{ON} , which charges C_T during the on time, contributes to supplying control power during the off time.

The power switch off time is controlled by the discharge of C_T which, in turn, is programmed by the regulated output voltage. The relationship between C_T discharge current, I_{DCHG} , and output voltage is illustrated as follows:



1. When $V_{OUT} = 0$, the off time is infinite. This feature provides inherent short circuit protection. However, to ensure output voltage startup when the output is not a short, a high value resistor, R_s , is placed in parallel with C_T to establish a minimum switching frequency.
2. As V_{OUT} rises above approximately 0.7V to its regulated value, I_{DCHG} is defined by R_{OFF} , and therefore is equal to:

$$I_{DCHG} = (V_{OUT} - 0.7V) / R_{OFF}$$

As V_{OUT} increases, I_{DCHG} increases resulting in the reduction of off time. The frequency of operation increases and V_{OUT} rises quickly to its regulated value.

3. In this region, a transconductance amplifier reduces I_{DCHG} in order to maintain V_{OUT} in regulation.
4. If V_{OUT} should rise above its regulation range, I_{DCHG} falls to zero and the circuit returns to the minimum frequency established by R_s and C_T .

The range of switching frequencies is established by R_{ON} , R_{OFF} , R_s , and C_T as follows:

$$\text{Frequency} = 1/(T_{ON} + T_{OFF})$$

$$T_{ON} = R_{ON} \cdot C_T \cdot 4.6V / (V_{IN} - 4.5V)$$

$$T_{OFF} (\text{max}) = 1.4 \cdot R_s \cdot C_T$$

Regions 1 and 4

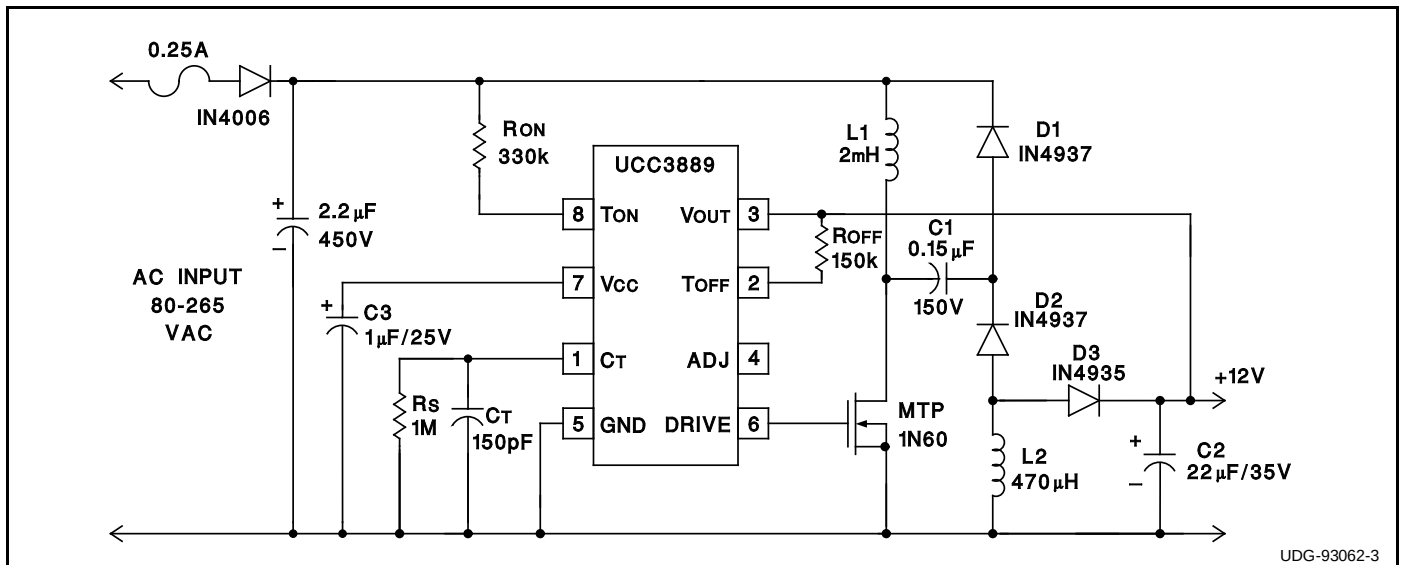
$$T_{OFF} = R_{OFF} \cdot C_T \cdot 3.7V / (V_{OUT} - 0.7V)$$

Region 2, excluding the effects of R_s which have a minimal impact on T_{OFF} .

The above equations assume that V_{CC} equals 9V. The voltage at T_{ON} increases from approximately 2.5V to 6.5V while C_T is charging. To take this into account, V_{IN} is adjusted by 4.5V in the calculation of T_{ON} . The voltage at T_{OFF} is approximately 0.7V.

DESIGN EXAMPLE

The UCC3889 regulates a 12 volt, 1 Watt nonisolated DC output from AC inputs between 80 and 265 volts. In this example, the IC is programmed to deliver a maximum on time gate drive pulse width of 2.4 microseconds which occurs at 80 VAC. The corresponding switching frequency is approximately 100kHz at low line, and overall efficiency is approximately 50%. Additional design information is available in Unitrode Application Note U-149.



UDG-93062-3

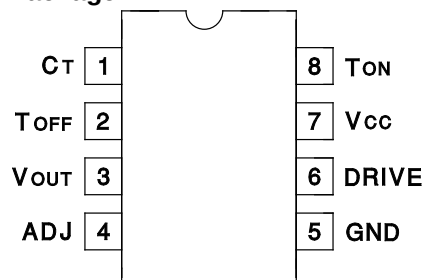
ABSOLUTE MAXIMUM RATINGS

I_{CC}	5mA
Current into TON Pin	1.5mA
Voltage on VOUT Pin	20V
Current into TOFF Pin	250 μ A
Storage Temperature	-65°C to +150°C

Note: Unless otherwise indicated, voltages are referenced to ground and currents are positive into, negative out of, the specified terminals.

CONNECTION DIAGRAM

DIL-8, SOIC-8 (Top View)
N or J, D Package



ELECTRICAL CHARACTERISTICS Unless otherwise stated, these specifications hold for $T_A = 0^\circ\text{C}$ to 70°C for the UCC3889, -40°C to $+85^\circ\text{C}$ for the UCC2889, and -55°C to $+125^\circ\text{C}$ for the UCC1889. No load at DRIVE pin ($C_{LOAD}=0$).

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
General					
VCC Zener Voltage	$I_{CC} < 1.5\text{mA}$	8.6	9.0	9.3	V
Startup Current	$V_{OUT} = 0$		150	250	μA
Operating Current $I(V_{OUT})$	$V_{OUT} = 11\text{V}$, $F = 150\text{kHz}$		1.2	2.5	mA
Under-Voltage-Lockout					
Start Threshold	$V_{OUT} = 0$	8.0	8.4	8.8	V
Minimum Operating Voltage after Start	$V_{OUT} = 0$	6.0	6.3	6.6	V
Hysteresis	$V_{OUT} = 0$	1.8			V
Oscillator					
Amplitude	$V_{CC} = 9\text{V}$	3.5	3.7	3.9	V
C_T to DRIVE high Propagation Delay	Overdrive = 0.2V		100	200	ns
C_T to DRIVE low Propagation Delay	Overdrive = 0.2V		50	100	ns
Driver					
VOL	$I = 20\text{mA}$, $V_{CC} = 9\text{V}$		0.15	0.4	V
	$I = 100\text{mA}$, $V_{CC} = 9\text{V}$		0.7	1.8	V
VOH	$I = -20\text{mA}$, $V_{CC} = 9\text{V}$	8.5	8.8		V
	$I = -100\text{mA}$, $V_{CC} = 9\text{V}$	6.1	7.8		V
Rise Time	$C_{LOAD} = 1\text{nF}$		35	70	ns
Fall Time	$C_{LOAD} = 1\text{nF}$		30	60	ns
Line Voltage Detection					
Charge Coefficient: $I_{CHG} / I(TON)$	$V_{CT} = 3\text{V}$, DRIVE = High, $I(TON) = 1\text{mA}$	0.73	0.79	0.85	
Minimum Line Voltage for Fault	$R_{ON} = 330\text{k}$	60	80	100	V
Minimum Current $I(TON)$ for Fault	$R_{ON} = 330\text{k}$		220		μA
On Time During Fault	$C_T = 150\text{pF}$, $V_{LINE} = \text{Min} - 1\text{V}$		2		μs
Oscillator Restart Delay after Fault			0.5		ms
Vout Error Amp					
V_{OUT} Regulated 12V (ADJ Open)	$V_{CC} = 9\text{V}$, $I_{DCHG} = I(TOFF)/2$	11.2	11.9	12.8	V
V_{OUT} Regulated 18V (ADJ = 0V)	$V_{CC} = 9\text{V}$, $I_{DCHG} = I(TOFF)/2$	16.5	17.5	19.5	V
Discharge Ratio: $I_{DCHG} / I(TOFF)$	$I(TOFF) = 50\mu\text{A}$	0.93	1.00	1.07	
Voltage at TOFF	$I(TOFF) = 50\mu\text{A}$	0.6	0.95	1.3	V
Regulation gm (Note 1)	Max $I_{DCHG} = 50\mu\text{A}$		1.0		mA/V
	Max $I_{DCHG} = 125\mu\text{A}$	0.8	1.7	2.9	mA/V

Note 1: gm is defined as $\frac{\Delta I_{DCHG}}{\Delta V_{OUT}}$ for the values of V_{OUT} when V_{OUT} is in regulation. The two points used to calculate gm are for I_{DCHG} at 65% and 35% of its maximum value.

PIN DESCRIPTIONS

ADJ: The ADJ pin is used to provide a 12V or an 18V regulated supply without additional external components. To select the 12V option, ADJ pin is left open. To select the 18V option, ADJ pin must be grounded. For other output voltages less than 18V, a resistor divider between VOUT, ADJ and GND is needed. Note, however, that for output voltages less than VCC, the device needs additional bootstrapping to VCC from an external source such as the line voltage. If so, precautions must be taken to ensure that total ICC does not exceed 5mA.

CT (timing capacitor): The signal voltage across CT has a peak-to-peak swing of 3.7V for 9V VCC. As the voltage on CT crosses the oscillator upper threshold, DRIVE goes low. As the voltage on CT crosses the oscillator lower threshold, DRIVE goes high.

DRIVE: This output is a CMOS stage capable of sinking 200mA peak and sourcing 150mA peak. The output voltage swing is 0 to VCC.

GND (chip ground): All voltages are measured with respect to GND.

TOFF (regulated output control): TOFF sets the discharge current of the timing capacitor through an external

resistor connected between VOUT and TOFF.

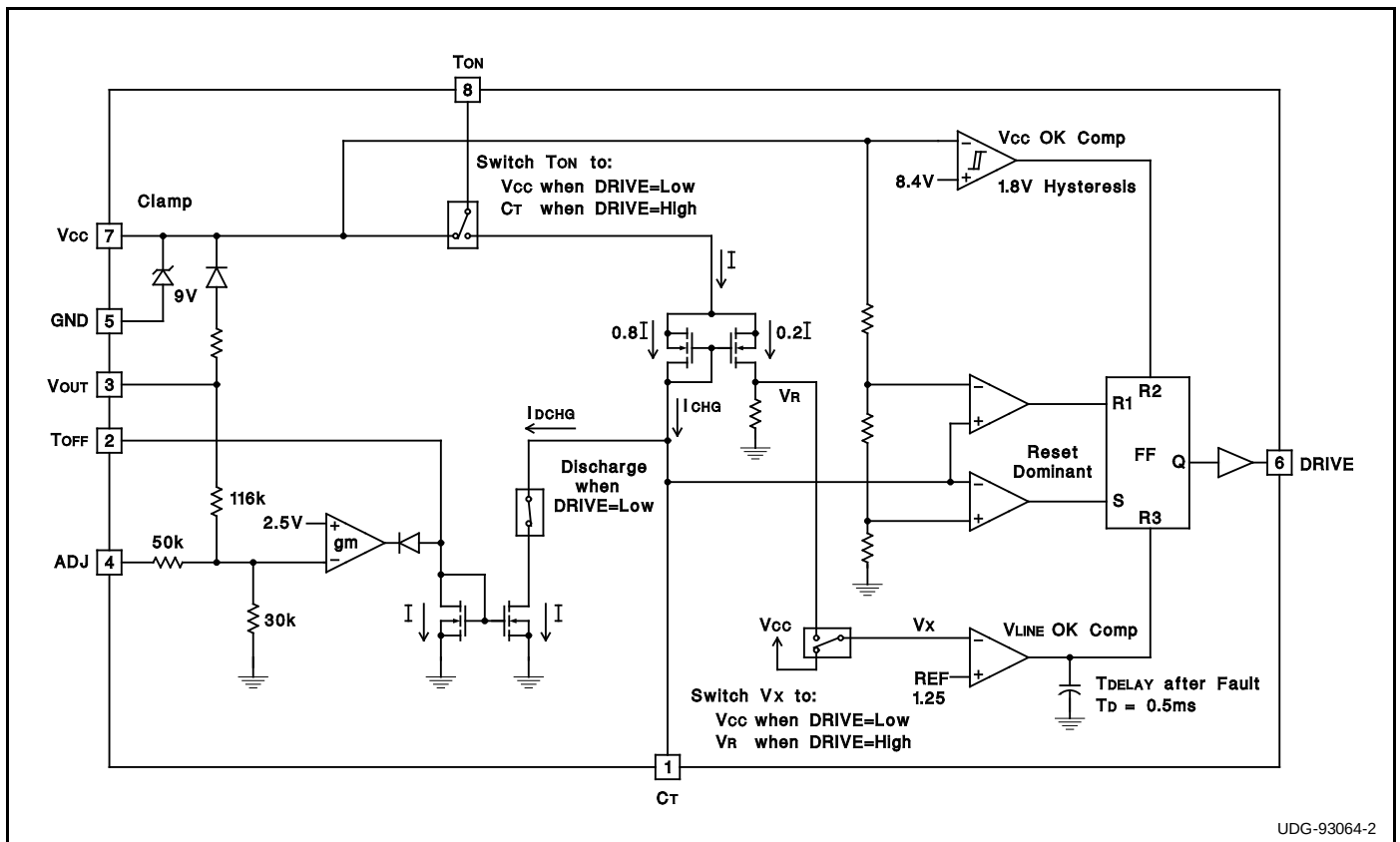
TON (line voltage control): TON serves three functions. When CT is discharging (off time), the current through TON is routed to VCC. When CT is charging (on time), the current through TON is split 80% to set the CT charge time and 20% to sense minimum line voltage which occurs for a TON current of 220μA. For a minimum line voltage of 80V, RON is 330kΩ.

The CT voltage slightly affects the value of the charge current during the on time. During this time, the voltage at the TON pin increases from approximately 2.5V to 6.5V.

VCC (chip supply voltage): The supply voltage of the device at pin VCC is internally clamped at 9V. Normally, VCC is not directly powered from an external voltage source such as the line voltage. In the event that VCC is directly connected to a voltage source for additional bootstrapping, precautions must be taken to ensure that total ICC does not exceed 5mA.

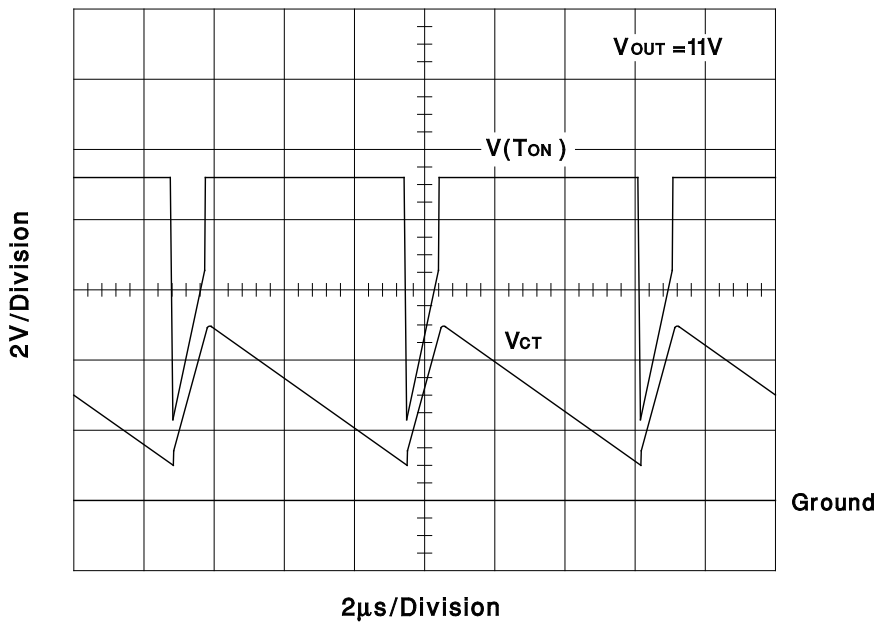
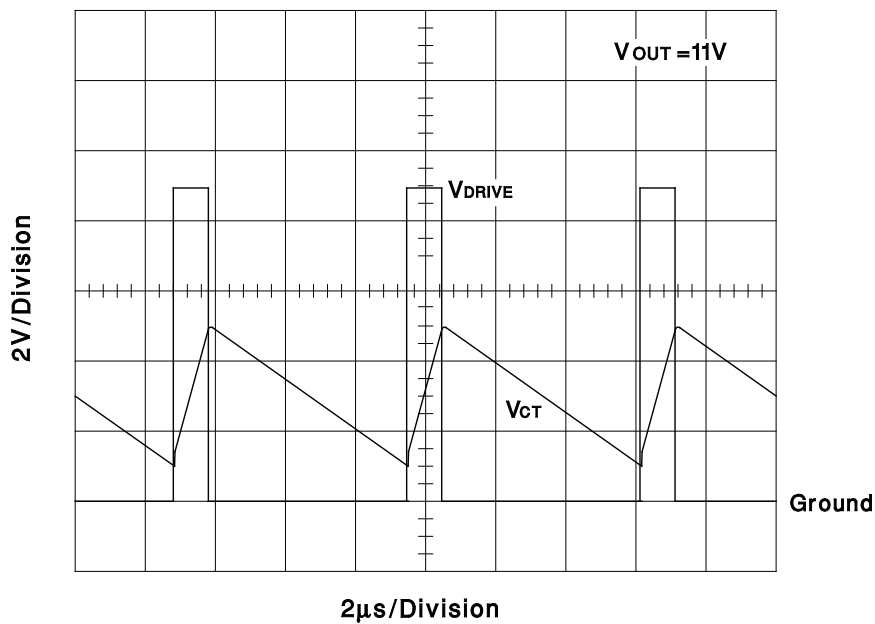
VOUT (regulated output): The VOUT pin is directly connected to the power supply output voltage. When VOUT is greater than VCC, VOUT bootstraps VCC.

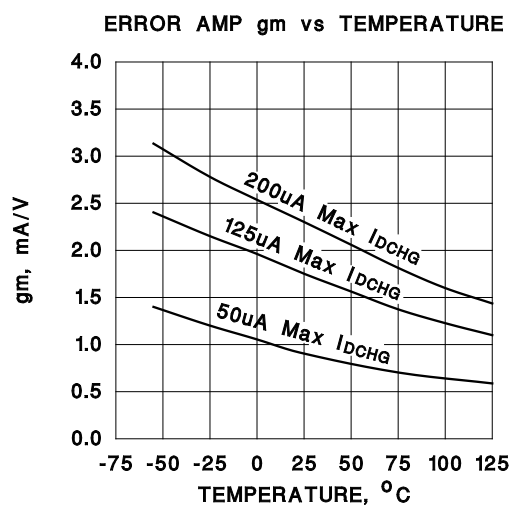
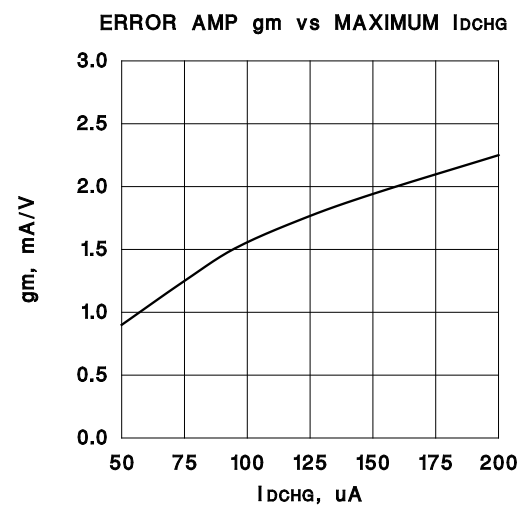
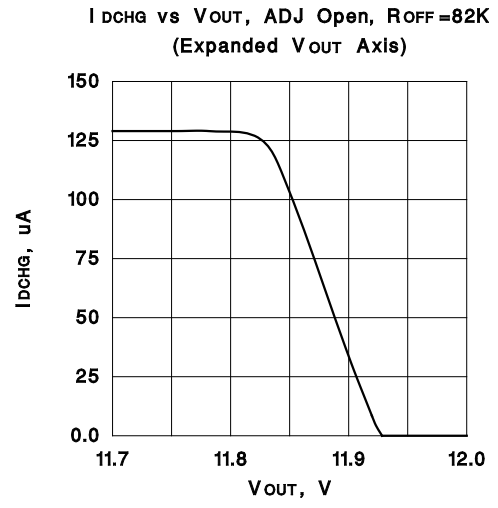
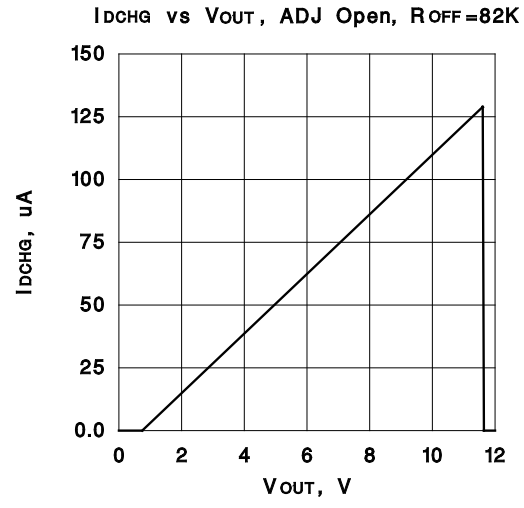
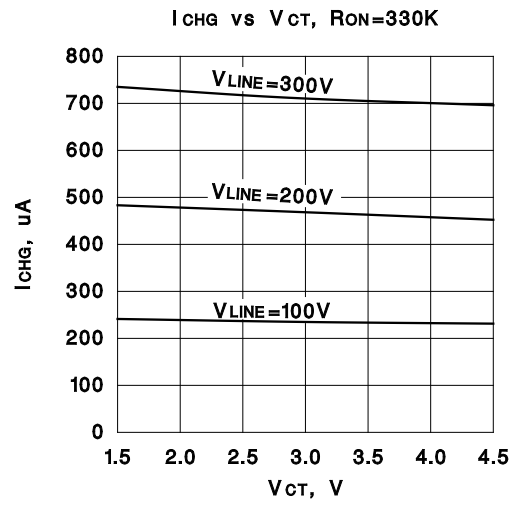
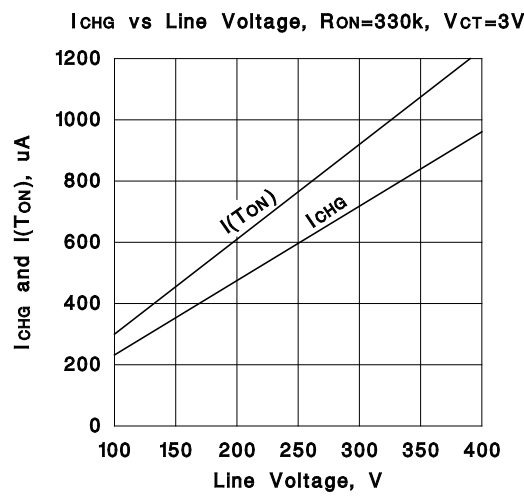
BLOCK DIAGRAM



UDG-93064-2

TYPICAL WAVEFORMS





PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
UCC2889D	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	UCC2889	Samples
UCC2889DTR	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	UCC2889	Samples
UCC2889DTRG4	ACTIVE	SOIC	D	8	2500	TBD	Call TI	Call TI	-40 to 85		Samples
UCC3889D	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UCC3889	Samples
UCC3889DG4	ACTIVE	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UCC3889	Samples
UCC3889DTR	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UCC3889	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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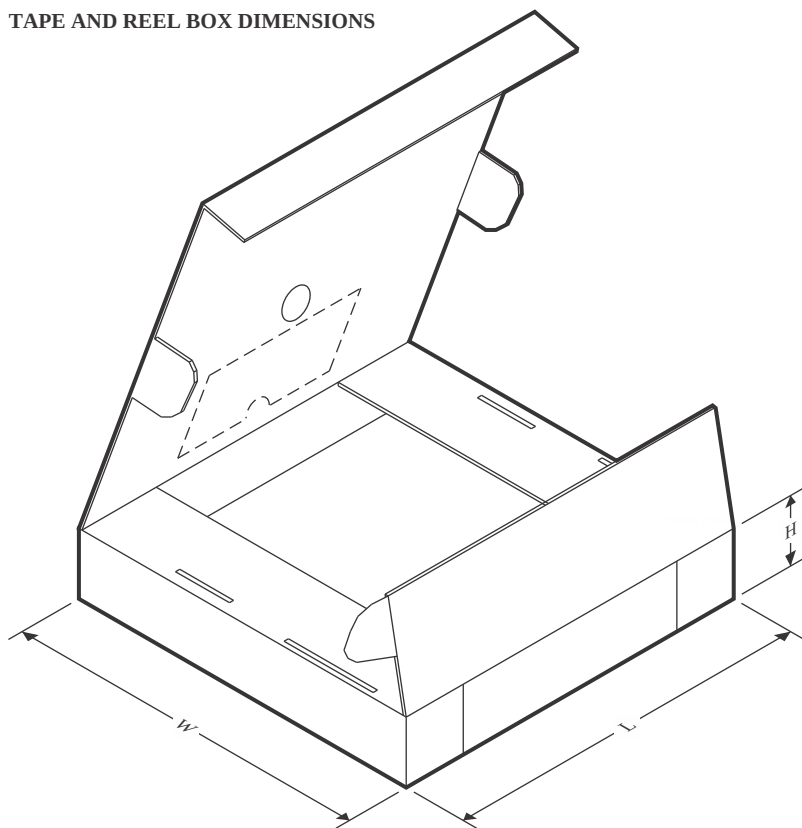
TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
UCC2889DTR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
UCC3889DTR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

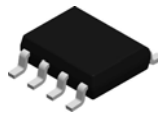
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
UCC2889DTR	SOIC	D	8	2500	356.0	356.0	35.0
UCC3889DTR	SOIC	D	8	2500	356.0	356.0	35.0

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
UCC2889D	D	SOIC	8	75	506.6	8	3940	4.32
UCC3889D	D	SOIC	8	75	506.6	8	3940	4.32
UCC3889DG4	D	SOIC	8	75	506.6	8	3940	4.32

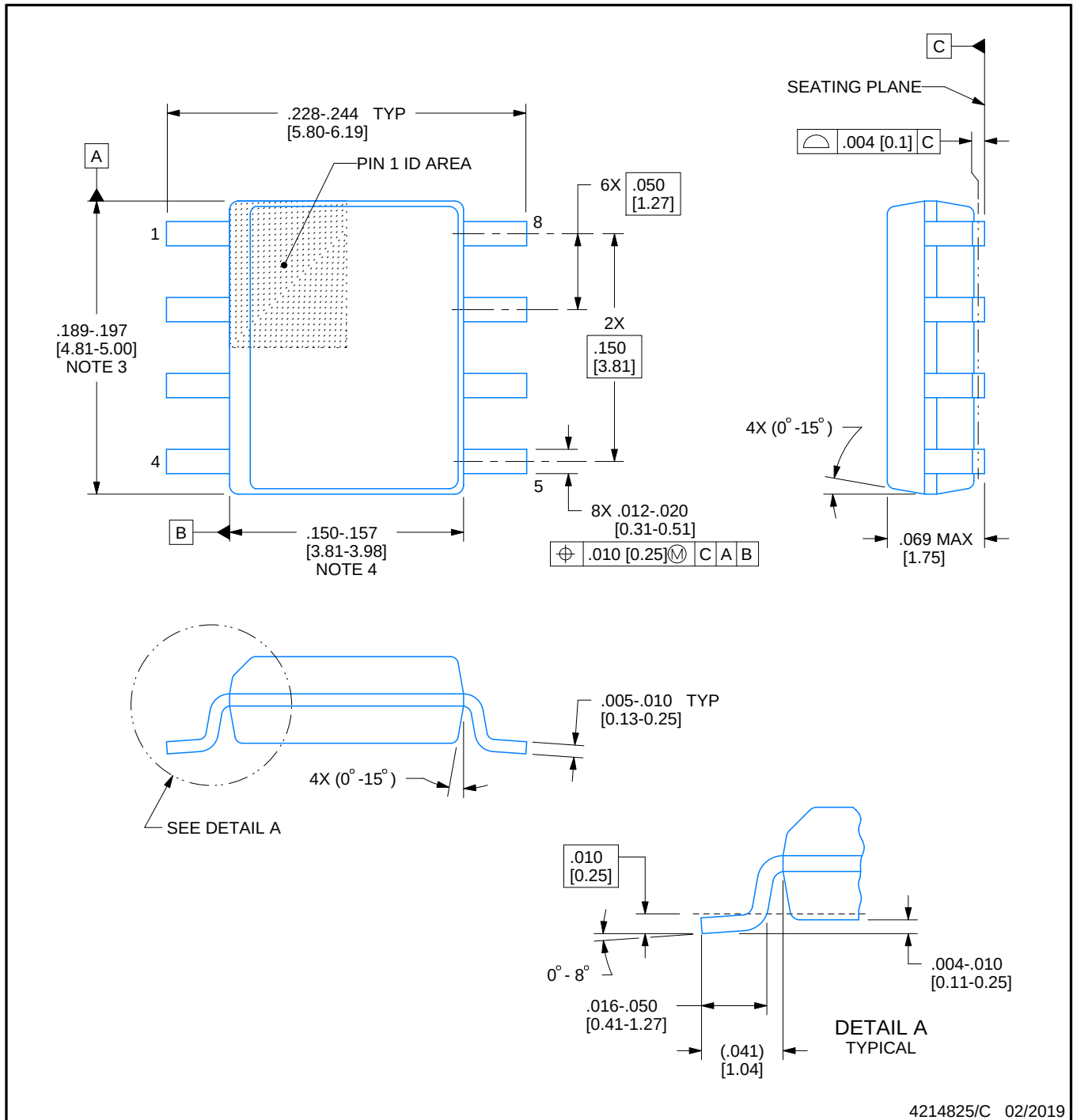


D0008A

PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

NOTES:

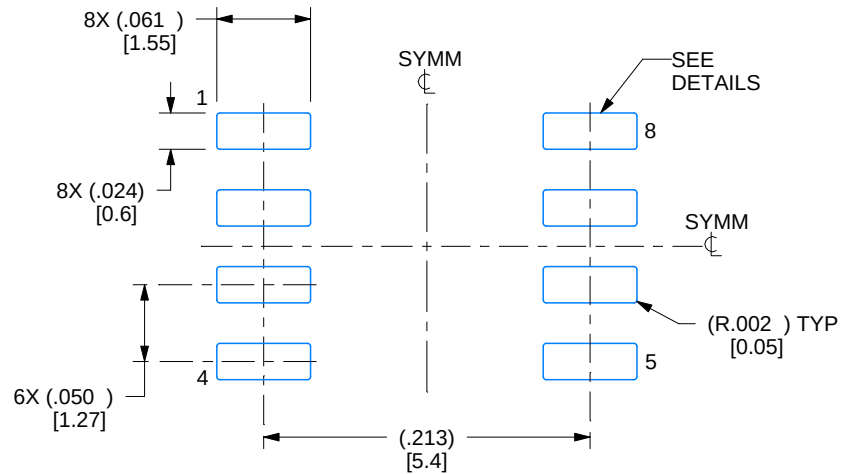
1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.

EXAMPLE BOARD LAYOUT

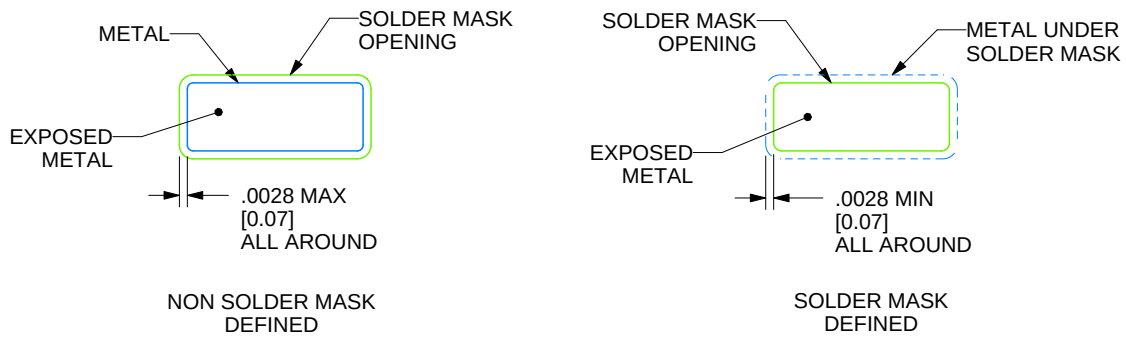
D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:8X



SOLDER MASK DETAILS

4214825/C 02/2019

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

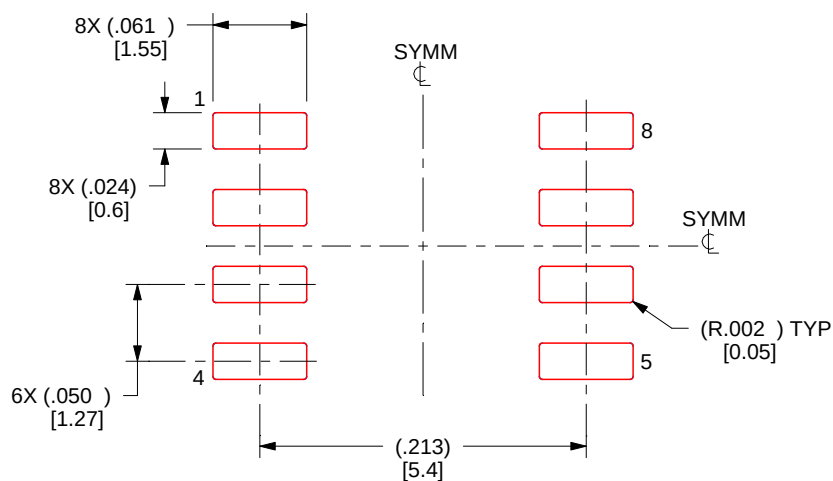
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE
BASED ON .005 INCH [0.125 MM] THICK STENCIL
SCALE:8X

4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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